RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT AND SUPPLEMENTAL RESPONSE TO RESTRICTION REQUIREMENT

Serial Number: 10/623,788 Filing Date: July 21, 2003

Title: STRAINED SEMICONDUCTOR BY FULL WAFER BONDING

Page 14 Dkt: 1303.109US1

## **REMARKS**

In response to the Notice of Non-Compliant Amendment mailed November 8, 2005, Applicant has herein included the status identifier for Claim 54 as required by the Notice.

In the Restriction Requirement mailed September 30, 2005, the Examiner has restricted the claims to one of the following inventions under 35 U.S.C. 121:

- I. Claims 1-53, drawn to a method of forming a wafer; and
- II. Claims 54-65, drawn to a wafer structure.

Applicant elects, without traverse, Group I, claims 1-53.

## RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT AND SUPPLEMENTAL RESPONSE TO RESTRICTION REQUIREMENT

Serial Number: 10/623,788 Filing Date: July 21, 2003

Title: STRAINED SEMICONDUCTOR BY FULL WAFER BONDING

## **CONCLUSION**

Applicant respectfully submits that the claims are in condition for allowance, and notification to that effect is earnestly requested. The Examiner is invited to telephone Applicant's attorney at (612) 373-6960 to facilitate prosecution of this application.

If necessary, please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

Respectfully submitted,

LEONARD FORBES ET AL.

By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A. P.O. Box 2938
Minneapolis, MN 55402
(612) 373-6960

Page 15

Dkt: 1303.109US1

Date 12 - 7 - 05 By	Mal Be
	Marvin L. Beekman
	Reg. No. 38,377
CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby Service with sufficient postage as first class mail, in an envelop Alexandria, VA 22313-1450 on this day of December 1.3 Decem	Cacia Lee
name .	Signatur <b>é</b>